

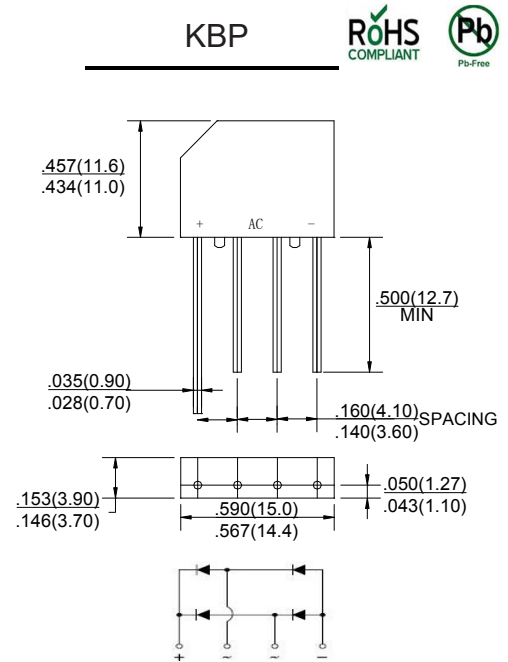
## Single Phase 2.0Amp Glass Passivated Bridge Rectifier

### Features

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Ideal for printed circuit boards
- Low reverse leakage
- High forward surge current capability
- High temperature soldering guaranteed:  
260°C/10 seconds, 0.375"(9.5mm) lead length,  
5 lbs. (2.3kg) tension

### Mechanical Data

- Case: Molded plastic body
- Terminals: Plated leads solderable per MIL-STD-750, Method
- Polarity 2026 : Polarity symbols marked on case
- Mounting Position: Any
- Weight : 0.069 ounce, 1.95 grams



Dimensions in inches and (millimeters)

### Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	Symbols	KBP2005	KBP201	KBP202	KBP204	KBP206	KBP208	KBP210	Units
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum average forward output rectified current at $T_A=50^\circ\text{C}$	$I_{(AV)}$	2.0							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	50.0							A
Rating for Fusing( $t<8.3\text{ms}$ )	$I^2t$	10.3							$\text{A}^2\text{s}$
Maximum instantaneous forward voltage at 2.0A	$V_F$	1.0							V
Maximum DC reverse current $T_A=25^\circ\text{C}$ at rated DC blocking voltage $T_A=125^\circ\text{C}$	$I_R$	2 200							$\mu\text{A}$
Typical Junction Capacitance (Note 1)	$C_J$	23							pF
Typical Thermal Resistance (Note 2)	$R_{qJA}$	28							$^\circ\text{C}/\text{W}$
Operating junction temperature range	$T_J$	-55 to +150							$^\circ\text{C}$
storage temperature range	$T_{STG}$	-55 to +150							$^\circ\text{C}$

NOTES: 1. Measured at 1.0 MHz and applied reverse voltage of 4.0 Volts.

2. Unit mounted on P.C. board with 0.47" x 0.47" (12x12mm) copper pads, 0.375" (9.5mm) lead length.



Ratings And Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

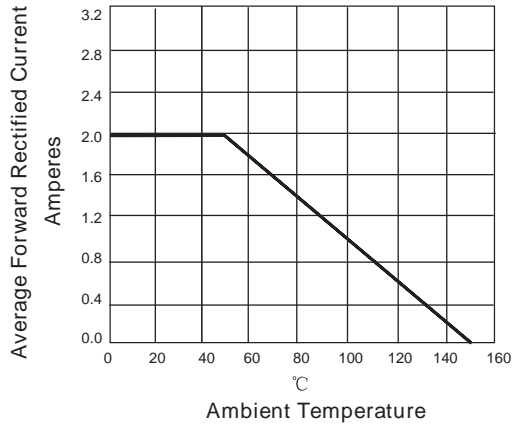


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PER LEG

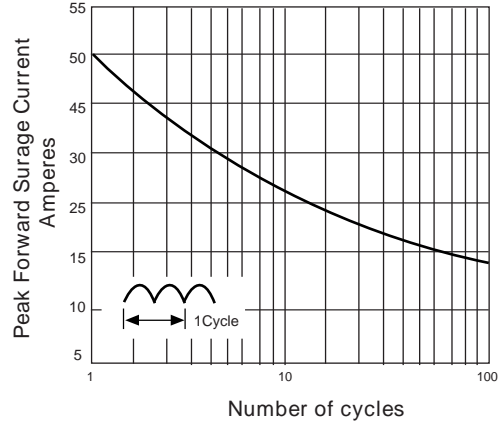


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

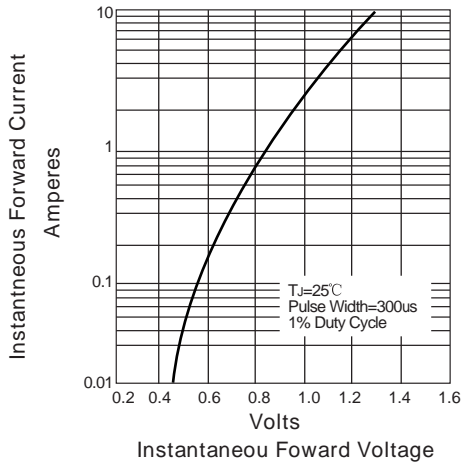


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS

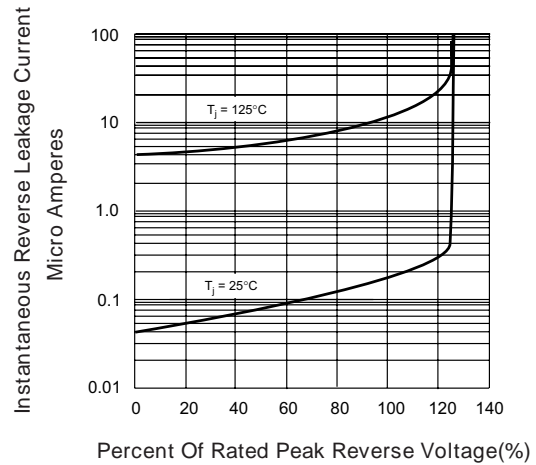
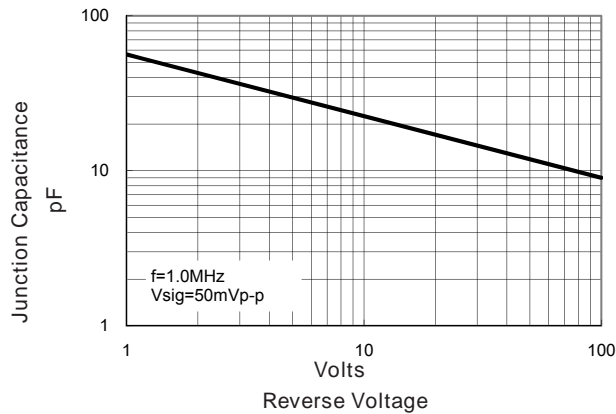
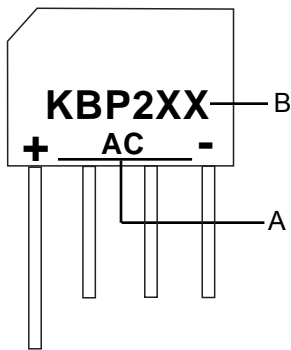


FIG. 5-TYPICAL JUNCTION CAPACITANCE



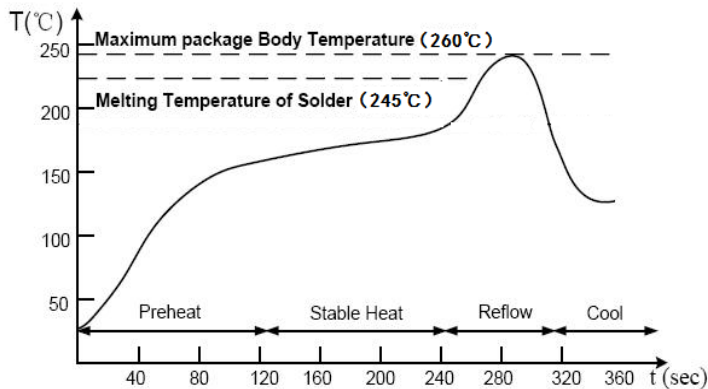


Marking



Symbol	Explanation
A	Polarity Symbol
B	Product Name, X: 005,01.....10

Suggested Soldering Temperature Profile



Note

- Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- The device can be exposed to a maximum temperature of 260°C for 10 seconds.
- Devices can be cleaned using standard industry methods and solvents.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.